

## Super-Junction Power Mosfet

### 1. Product Information

#### Features

- Low FOM  $R_{DS(ON)} \times Q_G$
- Better EMI
- Extremely low switching loss
- Good stability and uniformity
- 100% UIS and Isolation Tested

#### Applications

- Swit Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- Charge

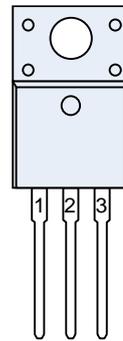
#### Quick reference

- $V_{DS} \cong 650\text{ V}$
- $I_D \leq 20\text{ A}$
- $R_{DS(ON)} \leq 190\text{ m}\Omega @ V_{GS} = 10\text{ V}$  (Type 160 m $\Omega$ )

#### Pin Description

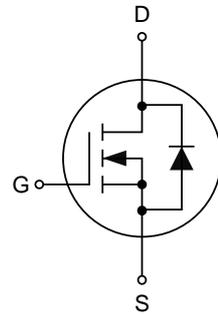
Pin	Description
1	Gate(G)
2	Drain(D)
3	Source(S)

#### Simplified Outline



Top View  
TO-220F

#### Symbol



#### Package Marking and Ordering Information

Product Name	Marking	Package	Packaging	Quantity (pcs)
KJC65R190CF	KJC65R190F	TO-220F	Tube	50

### 2. Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise noted)

Symbol	Parameter	Values	Unit
V <sub>DS</sub>	Drain-Source Voltage	650	V
V <sub>GS</sub>	Gate-Source Voltage	±30	V
I <sub>D</sub>	Continuous Drain Current (T <sub>C</sub> =25°C)	20	A
	Continuous Drain Current (T <sub>C</sub> =100°C)	12.5	A
I <sub>DM</sub>	Pulsed Drain Current <sup>[1]</sup>	80	A
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>[2]</sup>	388	mJ
P <sub>D</sub>	Power Dissipation <sup>[2]</sup>	52	W
dv/dt	Peak Diode Recovery dv/dt	5	V/ns
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Storage Temperature Range	-55 to 150	°C
R <sub>θJA</sub>	Thermal Resistance, Junction-Ambient <sup>[3]</sup>	89	°C/W
R <sub>θJC</sub>	Thermal Resistance, Junction-Case <sup>[3]</sup>	2.4	°C/W

## 3. Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

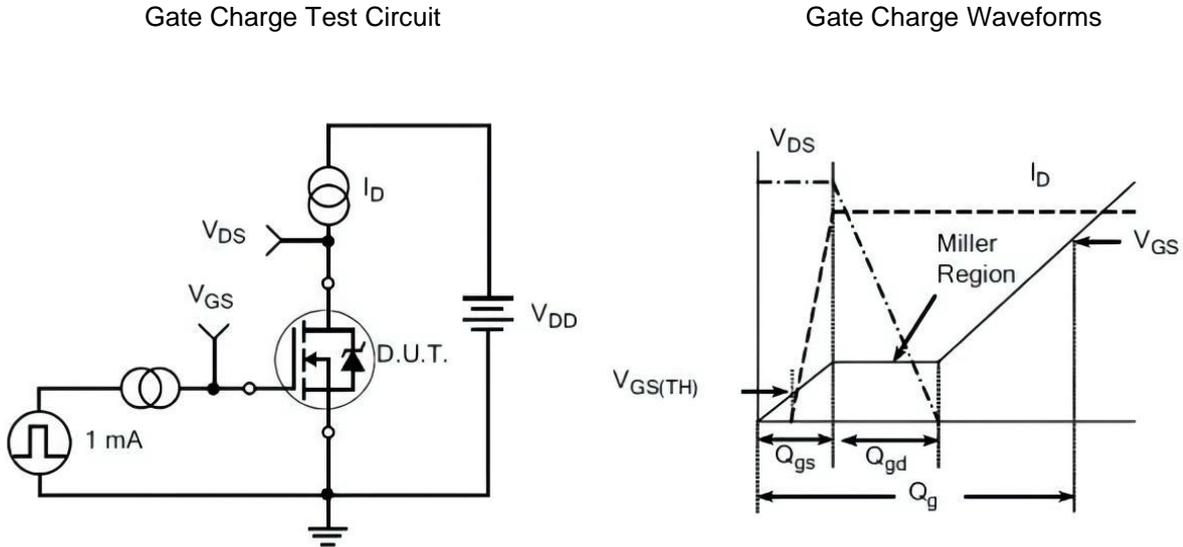
Symbol	Parameter	Test Conditions	Min	Type	Max	Unit
<b>Static Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0 V, I <sub>D</sub> =250 μA	650	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =650 V, V <sub>GS</sub> =0 V	-	-	1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±30 V, V <sub>DS</sub> =0 V	-	-	±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA	2.5	3.5	4.5	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A	-	160	190	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, F=1 MHz	-	1655	-	pF
C <sub>oss</sub>	Output Capacitance		-	69	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	1.2	-	pF
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DS</sub> =325 V, I <sub>D</sub> =20 A, R <sub>G</sub> =25 Ω, V <sub>GS</sub> =10V	-	34	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	37	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time		-	148	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	36	-	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =325 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =10 V	-	34	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	7	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	12	-	nC
<b>Source-Drain Diode Characteristics</b>						
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>F</sub> =20 A	-	-	1.4	V
I <sub>S</sub>	Diode Continuous Forward Current		-	-	20	A
I <sub>SM</sub>	Maximum Pulsed Body-Diode Forward Current		-	-	60	A
T <sub>rr</sub>	Reverse Recovery Time	V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, di/dt=100 A/μs	-	301	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	4.47	-	μC

Notes:

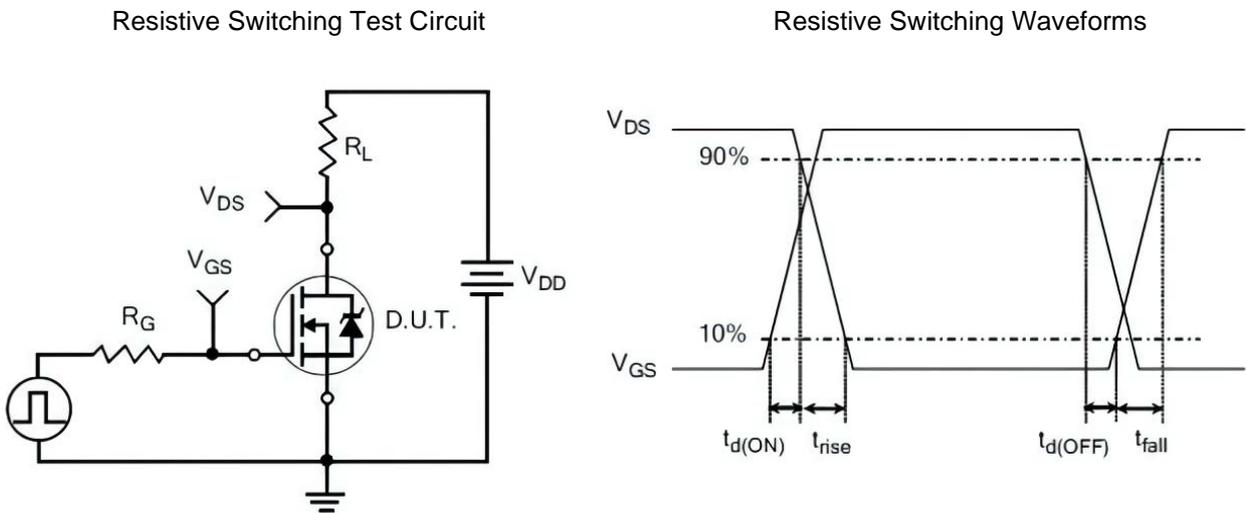
- Limited by maximum junction temperature, maximum duty cycle is 0.75.
- T<sub>J</sub>=25°C, V<sub>DD</sub>=50 V, V<sub>GS</sub>=10 V, R<sub>G</sub>=25 Ω.
- Mount on minimum PCB layout.

## 4. Test Circuits and Waveforms ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

**Table 1. Gate Charge Test Circuit and Waveforms**

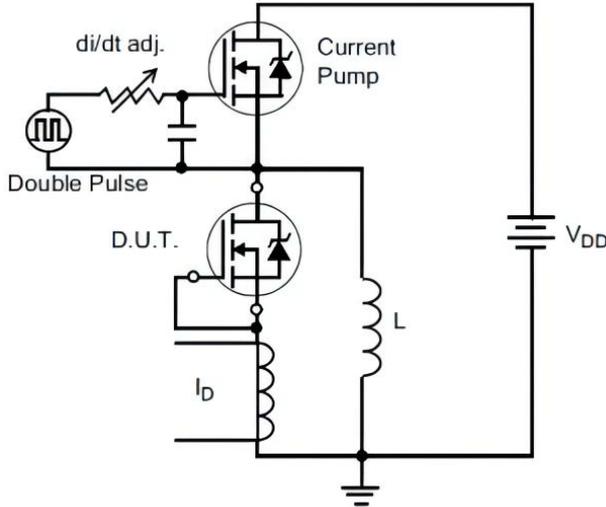


**Table 2. Resistive Switching Test Circuit and Waveforms**

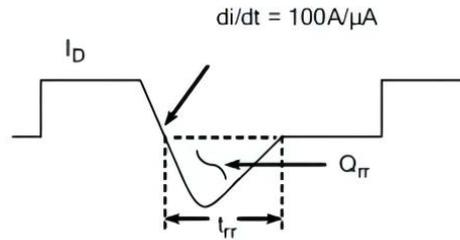


**Table 3. Diode Recovery Test Circuit and Waveforms**

Diode Recovery Test Circuit

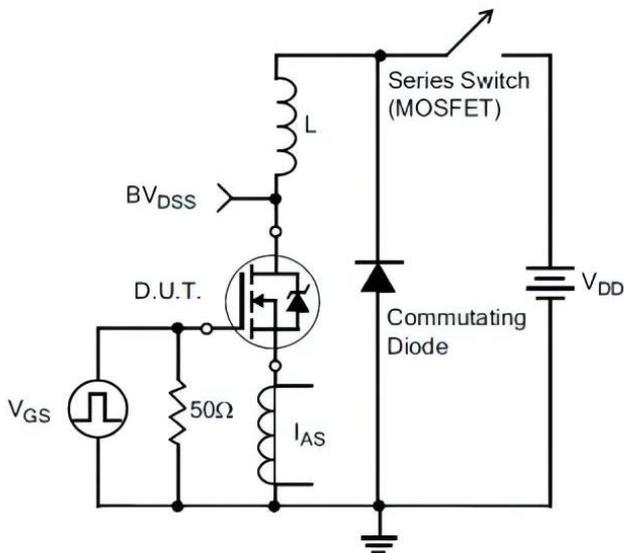


Diode Recovery Waveforms

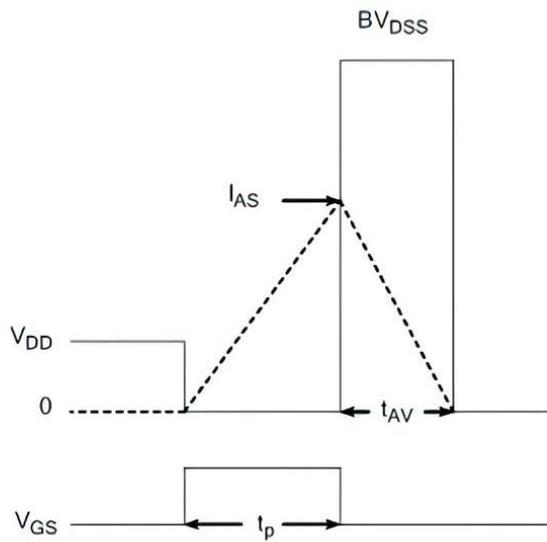


**Table 4. Unclamped inductive Switching (UIS) Test Circuit and Waveforms**

Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



$$E_{AS} = \frac{I_{AS}^2 L}{2}$$

## 5. Electrical Characteristics

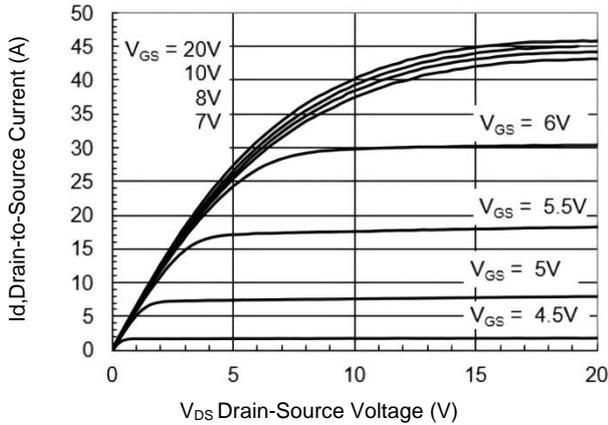


Figure 1. Typical Output Characteristics

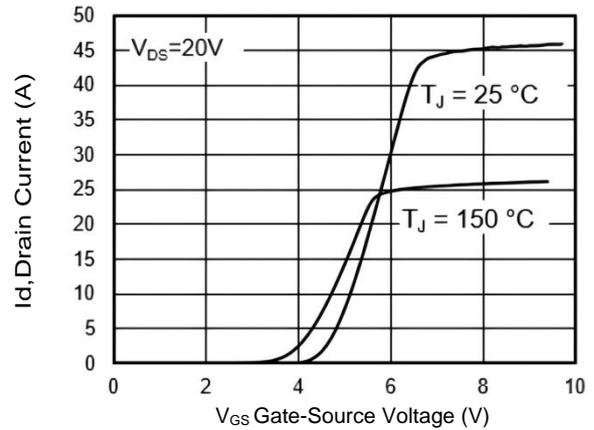


Figure 2. Typical Transfer Characteristics

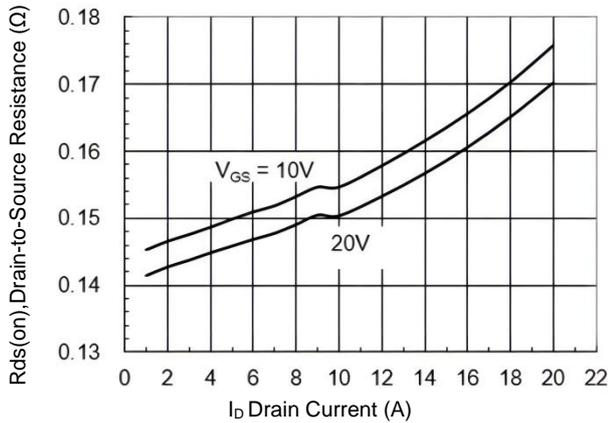


Figure 3. On-Resistance versus Drain Current

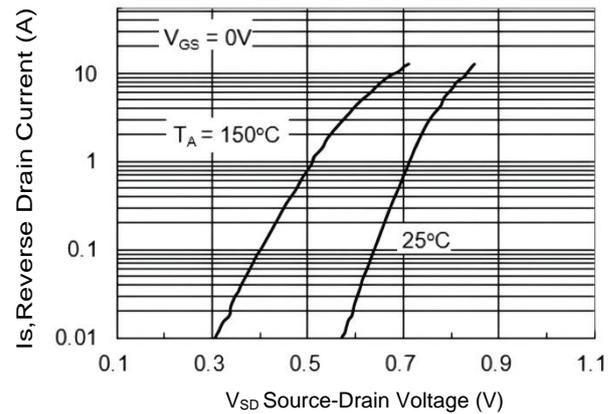


Figure 4. Diode forward voltage versus Current

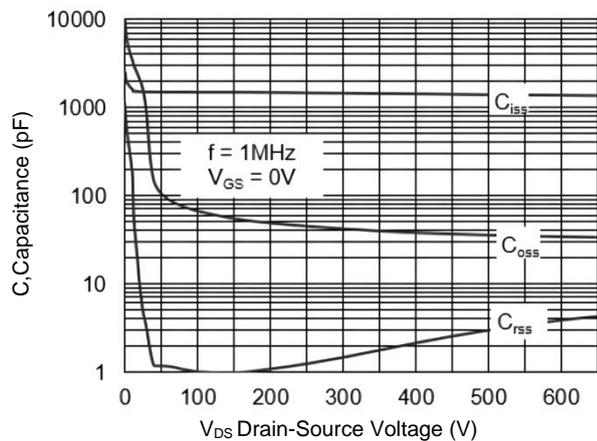


Figure 5. Typical Capacitance versus  $V_{DS}$

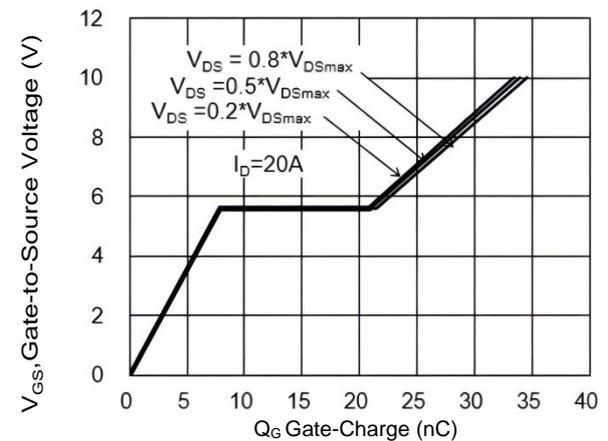


Figure 6. Typical Gate Charge versus  $V_{GS}$

## 5. Electrical Characteristics (cont.)

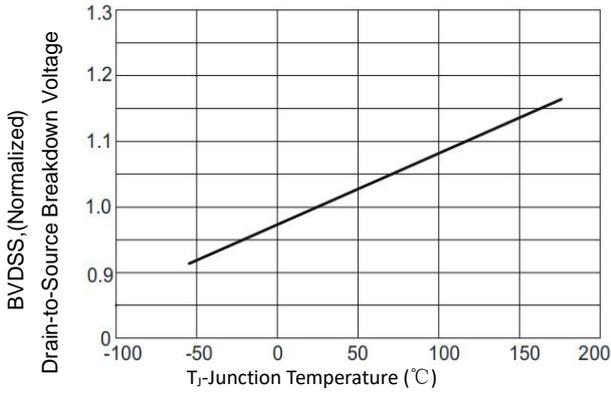


Figure 7.  $BV_{DSS}$  Variation with Temperature

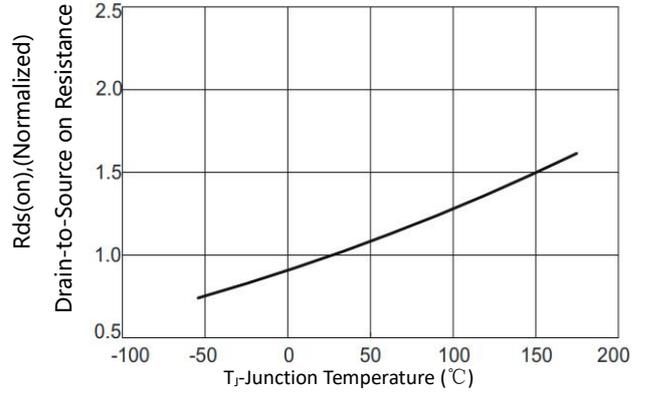


Figure 8. On-Resistance Variation with Temperature

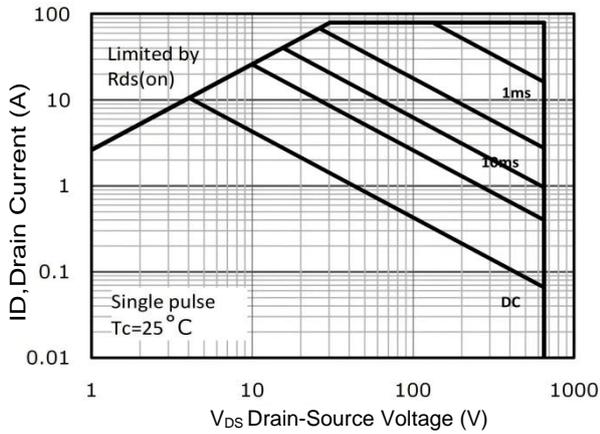


Figure 9. Maximum Safe Operating Area

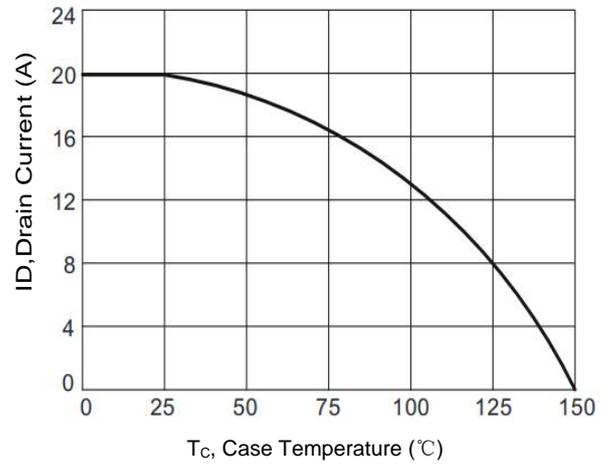
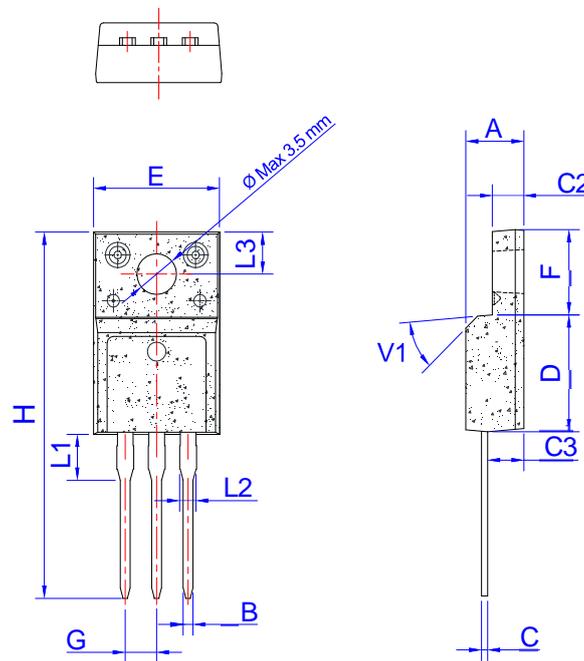


Figure 10. Maximum Continuous Drain Current versus Case Temperature

## 6. Package Mechanical Data

- TO-220F Package



Ref.	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	4.50		4.90
B	0.74	0.80	0.83
C	0.47		0.65
C2	2.45		2.75
C3	2.60		3.00
D	8.80		9.30
E	9.80		10.4
F	6.40		6.80
G		2.54	
H	28.0		29.8
L1		3.63	
L2	1.14		1.70
L3		3.30	
V1		45°	